# imall

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### 3A, 20V - 200V Surface Mount Schottky Barrier Rectifier

#### **FEATURES**

- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for over-voltage protection
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

#### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.21 g (approximately)

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)											
PARAMETER	SYMBOL	SS	SS	SS	SS	SS	SS	SS	SS	SS	UNIT
		32	33	34	35	36	39	310	315	320	
Marking code on the device		SS 32	SS 33	SS 34	SS 35	SS 36	SS 39	SS 310	SS 315	SS 320	
Repetitive peak reverse voltage	V <sub>RRM</sub>	20	30	40	50	60	90	100	150	200	V
Reverse voltage, total rms value	$V_{R(RMS)}$	14	21	28	35	42	63	70	105	140	V
Maximum DC blocking voltage	V <sub>DC</sub>	20	30	40	50	60	90	100	150	200	V
Forward current	I <sub>F(AV)</sub>					3					А
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>		100				7	75			A
Critical rate of rise of off-state voltage	dV/dt	10,000			V/µs						
Junction temperature	TJ	- 55 to +125 - 55 to +150			°C						
Storage temperature	T <sub>STG</sub>				- 5	55 to +1	50				°C

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I <sub>F(AV)</sub>	3	А			
V <sub>RRM</sub>	20 - 200	V			
Package	DO-214AB (SMC)				
Configuration	Sing	gle die			





DO-214AB (SMC)



THERMAL PERFORMANCE							
PARAMETER	SYMBOL	LIMIT	UNIT				
Junction-to-lead thermal resistance per diode	R <sub>eJL</sub>	17	°C/W				
Junction-to-ambient thermal resistance per diode	R <sub>eJA</sub>	55	°C/W				

PARAMETER		CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
	SS32 SS33 SS34			-	0.50	v
Forward voltage per diode <sup>(1)</sup>	SS35 SS36	I <sub>F</sub> = 3A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	0.75	V
	SS39 SS310			-	0.85	V
	SS315 SS320			-	0.95	V
	SS32 SS33 SS34			-	0.40	V
Forward voltage per diode <sup>(1)</sup>	SS35 SS36	I <sub>F</sub> = 3A, T <sub>J</sub> = 100°C	V <sub>F</sub>	-	0.65	V
	SS39 SS310			-	0.70	V
	SS315 SS320			-	0.80	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	SS32 SS33 SS34 SS35 SS36	T <sub>J</sub> = 25°C	I <sub>R</sub>	-	0.5	mA
diode (=)	SS39 SS310 SS315 SS320		'n	-	0.1	mA
	SS32 SS33 SS34			-	10	mA
Reverse current @ rated $V_R$ per diode $^{(2)}$	SS35 SS36	T <sub>J</sub> = 100°C	I <sub>R</sub>	-	5	mA
	SS39 SS310 SS315 SS320		'n	-	-	mA
	SS32 SS33 SS34			-	-	mA
Reverse current @ rated $V_R$ per diode $^{(2)}$	rse current @ rated V <sub>B</sub> per SS35	I <sub>R</sub>	-	-	mA	
	SS39 SS310 SS315 SS320			-	0.5	mA

#### Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms



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RDERING INFORMATION						
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING	
		R7	G	SMC	850 / 7" Plastic reel	
		R6		SMC	3,000 / 13" Paper reel	
SS3xx (Note 1)	н	M6		SMC	3,000 / 13" Plastic reel	
		V7		Matrix SMC	850 / 7" Plastic reel	
		V6		Matrix SMC	3,000 / 13" Plastic reel	

#### Note :

1. "xx" defines voltage from 20V (SS32) to 200V (SS320)

EXAMPLE						
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
SS32HR7G	SS32	Н	R7	G	AEC-Q101 qualified Green compound	



#### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

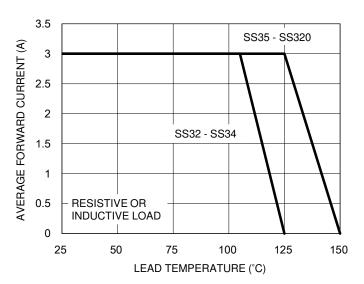


Fig.1 Forward Current Derating Curve

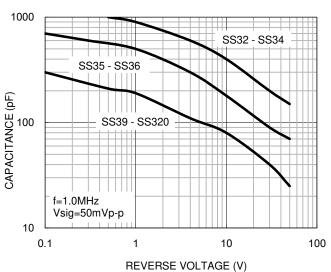
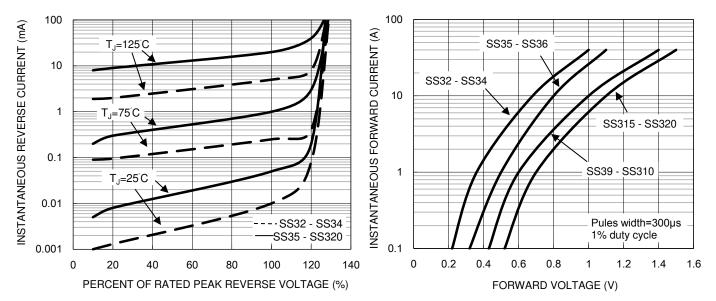


Fig.2 Typical Junction Capacitance

#### Fig.3 Typical Reverse Characteristics

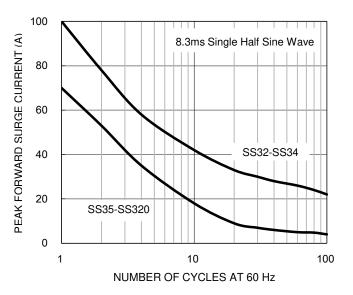




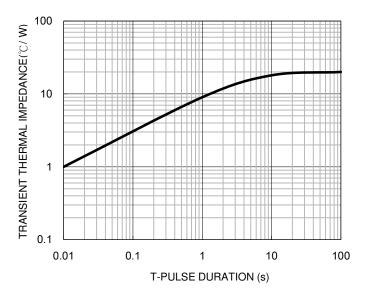


#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 



#### Fig.5 Maximum Non-repetitive Forward Surge Current

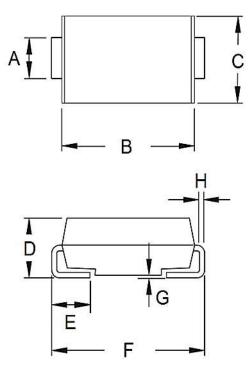


#### **Fig.6 Typical Transient Thermal Characteristics**



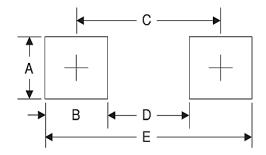
#### PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM.	Unit	(mm)	Unit (inch)		
DIM.	Min.	Max.	Min.	Max.	
Α	2.90	3.20	0.114	0.126	
В	6.60	7.11	0.260	0.280	
С	5.59	6.22	0.220	0.245	
D	2.00	2.62	0.079	0.103	
E	1.00	1.60	0.039	0.063	
F	7.75	8.13	0.305	0.320	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

#### SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
E	9.40	0.370

#### **MARKING DIAGRAM**



- P/N =Marking Code
- G =Green Compound
- YW =Date Code
- F =Factory Code



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